

PG-TSSLP-2-3

Overview

General Information

Package Material	PG
Package Family	TSSLP
Leads/Balls	2
Dash Version	3

Outline

Dimensions

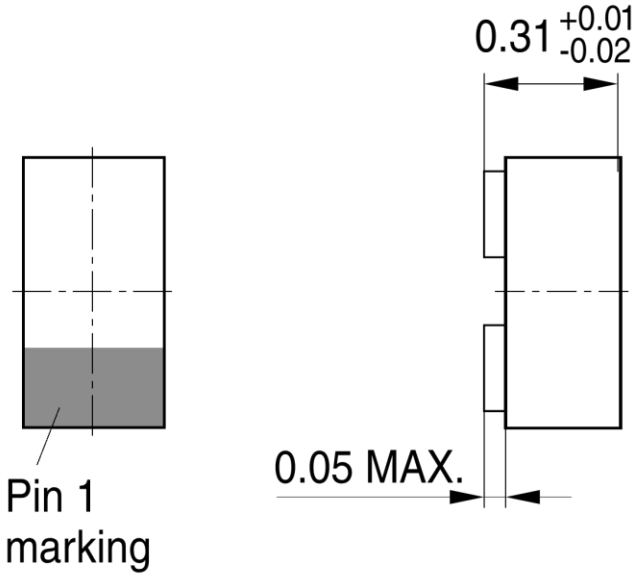
Body Length (mm)	0.62
Body Width (mm)	0.32
Lead/Ball Pitch (mm)	0.3550

Exposed Pad

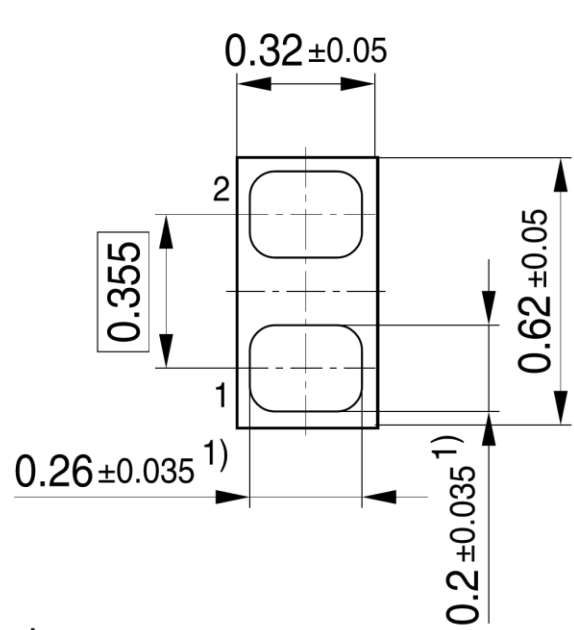
Heatslug	NONE
Exposed Paddle	YES

Outline

Top view



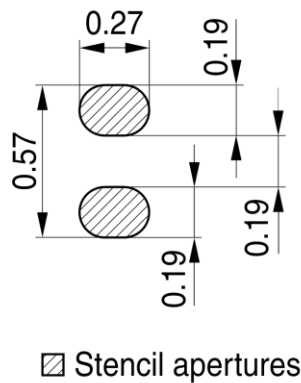
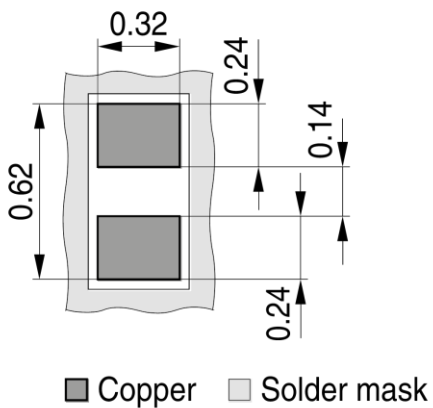
Bottom view



1) Dimension applies to plated terminals

TSSLP-2-3, -4-PO V01

Footprint Dimensions



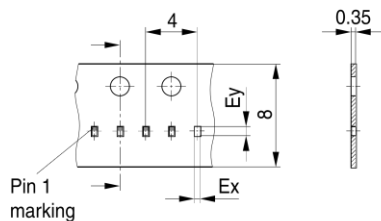
■ Copper □ Solder mask

▨ Stencil apertures

TSSLP-2-3, -4-FP V02

Packing

Tape & Reel



Tape type	Ex	Ey
Punched Tape	0.43	0.73
Embossed Tape	0.37	0.67

Deliveries can be both tape types (no selection possible).
 Specification allows identical processing (pick & place) by users.

TSSLP-2-3, -4-TP V03

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Document reference

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